

**Harvatek Surface Mount Chip LED Data Sheet
HT-T3212DND**

Official Product	Product: HT-T3212DND			Data Sheet No.
Tentative Product	*****			HT-T3212DND
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		June 25, 2013	Version of 1.0	Page 1/20

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DISCLAIMER

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

	Specification	Material	Quantity
Iv	82 – 121.55 lm @150mA / Ta=25 ^o C, ± 10%		
XY	Refer to page 6-8 @150mA / Ta=25 ^o C, ± 0.005		
Vf	7.0V max @150mA / Ta=25 ^o C, ± 0.05 V		
Ir	< 100 µA @ VR= 5 V		
Resin	Yellow	Silicone Resin	
Carrier tape	Per EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

ATTENTION: Electrostatic Discharge (ESD) protection




The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

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Label Specifications

HARVATEK TECHNOLOGIES		Date: yyyy/mm/dd
CUSTOMER P/N: 		
HARVATEK P/N: 	QTY: PCS 	
LOT NO: 	QC	
IV BIN: COLOR BIN: VF:		

Harvatek P/N:

H T - T 32 1 2 D N D - Y Y Y Y

Series Name	Emitting Color	Customer Code
HT-T3212 HT: Harvatek T3212: 3.0 (L) x 3.0 (W) x 0.52 (H) mm	DND CRI > 80 @150mA per chip	YYYY Customer Product Code (TBD)

Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	A	2	2	L	1	2
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2010-A 2011-B 2012-C 2013-D . .	1:Jan. 2:Feb. A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C ... 26:Z 27:7 28:8 29:9 30:3 31:4	01~ZZ		000~ZZZ		

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■ **Luminous Intensity (Iv) Bin:**

Bin	Luminous Intensity Range (lm)	
	Minimum	Maximum
TD2	82	87.4
UA1	87.4	93.5
UB1	93.5	99.6
UC2	99.6	106.6
UD2	106.6	113.6
VA1	113.6	121.55

@150mA / Ta=25° C, Tolerance: ± 10%

■ **Forward Voltage (V_F) Bin:**

Color	Bin Code	Spec. Range
White (TW)	R1	6.0 – 6.1V
	R2	6.1 – 6.2V
	R3	6.2 – 6.3V
	R4	6.3 – 6.4V
	S1	6.4 – 6.5V
	S2	6.5 – 6.6V
	S3	6.6 – 6.7V
	S4	6.7 – 6.8V
	T1	6.8 – 6.9V
	T2	6.9 – 7.0V

@150mA / Ta=25°C, Tolerance: ± 0.05 V

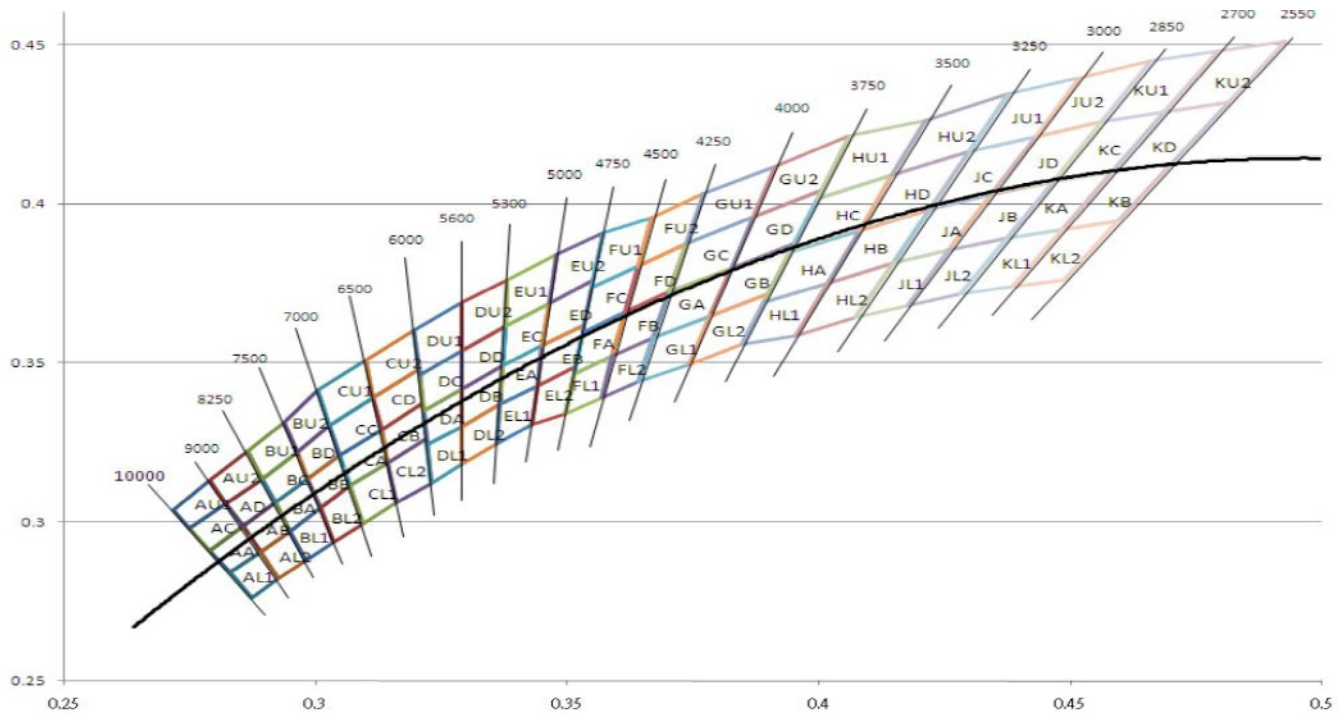
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Chromaticity Bin (for TW only):

AA	0.283	0.284	BA	0.295	0.297	CA	0.3068	0.3113	DA	0.3222	0.3243	EA	0.3366	0.3369
	0.279	0.291		0.292	0.306		0.3048	0.3207		0.3215	0.335		0.3371	0.349
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554
	0.289	0.2905		0.3009	0.3042		0.3144	0.3186		0.329	0.33		0.344	0.3427
AB	0.283	0.284	BB	0.295	0.297	CB	0.3068	0.3113	DB	0.3222	0.3243	EB	0.3366	0.3369
	0.289	0.2905		0.3009	0.3042		0.3144	0.3186		0.329	0.33		0.344	0.3427
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554
	0.292	0.306		0.3048	0.3207		0.3213	0.3373		0.3371	0.349		0.3533	0.362
AC	0.295	0.297	BC	0.3068	0.3113	CC	0.3207	0.3243	DC	0.3366	0.3369	EC	0.3515	0.3407
	0.289	0.2905		0.3009	0.3042		0.3144	0.3186		0.329	0.33		0.344	0.3427
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554
	0.279	0.291		0.292	0.306		0.3048	0.3207		0.3215	0.335		0.3371	0.349
AD	0.275	0.298	BD	0.2895	0.3135	CD	0.3028	0.3304	DD	0.3207	0.3462	ED	0.3376	0.3616
	0.28225	0.30575		0.2962	0.322		0.3115	0.3391		0.329	0.3538		0.3463	0.3687
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554
	0.279	0.291		0.292	0.306		0.3048	0.3207		0.3215	0.335		0.3371	0.349
AL1	0.2055	0.2905	BL1	0.2904	0.3133	CL1	0.313	0.329	DL1	0.329	0.3417	EL1	0.3451	0.3554
	0.28225	0.30575		0.2962	0.322		0.3115	0.3391		0.329	0.3538		0.3463	0.3687
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554
	0.289	0.2905		0.3009	0.3042		0.3144	0.3186		0.329	0.33		0.344	0.3427
AL2	0.283	0.284	BL2	0.298	0.288	CL2	0.3093	0.2993	DL2	0.3231	0.312	EL2	0.3361	0.3245
	0.289	0.2905		0.3009	0.3042		0.3068	0.3113		0.3222	0.3243		0.3366	0.3369
	0.2925	0.282		0.3037	0.2937		0.3144	0.3186		0.329	0.33		0.344	0.3428
	0.2874	0.276		0.298	0.288		0.3161	0.3059		0.329	0.318		0.3429	0.3307
AU1	0.2925	0.282	BU1	0.298	0.288	CU1	0.3093	0.2993	DU1	0.3231	0.312	EU1	0.3361	0.3245
	0.289	0.2905		0.3009	0.3042		0.3068	0.3113		0.3222	0.3243		0.3366	0.3369
	0.295	0.297		0.3068	0.3113		0.3144	0.3186		0.329	0.33		0.344	0.3428
	0.298	0.288		0.3037	0.2937		0.3161	0.3059		0.329	0.318		0.3429	0.3307
AU2	0.2925	0.282	BU2	0.298	0.288	CU2	0.3093	0.2993	DU2	0.3231	0.312	EU2	0.3361	0.3245
	0.289	0.2905		0.3009	0.3042		0.3068	0.3113		0.3222	0.3243		0.3366	0.3369
	0.295	0.297		0.3068	0.3113		0.3144	0.3186		0.329	0.33		0.344	0.3428
	0.298	0.288		0.3037	0.2937		0.3161	0.3059		0.329	0.318		0.3429	0.3307
FA	0.275	0.290	GA	0.2695	0.3135	HA	0.3020	0.3304	JA	0.3207	0.3462	KA	0.3376	0.3616
	0.2718	0.3036		0.2864	0.3221		0.3005	0.3415		0.3196	0.3602		0.3381	0.3762
	0.279	0.313		0.2937	0.3312		0.3099	0.3509		0.329	0.369		0.348	0.384
	0.28225	0.30575		0.2962	0.322		0.3115	0.3391		0.329	0.3538		0.3463	0.3687
FB	0.275	0.290	GB	0.2695	0.3135	HB	0.3020	0.3304	JB	0.3207	0.3462	KB	0.3376	0.3616
	0.2718	0.3036		0.2864	0.3221		0.3005	0.3415		0.3196	0.3602		0.3381	0.3762
	0.279	0.313		0.2937	0.3312		0.3099	0.3509		0.329	0.369		0.348	0.384
	0.28225	0.30575		0.2962	0.322		0.3115	0.3391		0.329	0.3538		0.3463	0.3687
FC	0.2064	0.3221	GC	0.3005	0.3415	HC	0.3196	0.3602	JC	0.3301	0.3762	KC	0.3371	0.3907
	0.2895	0.3135		0.3028	0.3304		0.3205	0.3481		0.3376	0.3616		0.3551	0.376
	0.292	0.306		0.3048	0.3207		0.3213	0.3373		0.3371	0.349		0.3533	0.362
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554
FD	0.283	0.284	GD	0.298	0.288	HD	0.3093	0.2993	JD	0.3231	0.312	KD	0.3361	0.3245
	0.289	0.2905		0.3009	0.3042		0.3068	0.3113		0.3222	0.3243		0.3366	0.3369
	0.2925	0.282		0.3037	0.2937		0.3144	0.3186		0.329	0.33		0.344	0.3428
	0.2874	0.276		0.298	0.288		0.3161	0.3059		0.329	0.318		0.3429	0.3307
FL1	0.2925	0.282	GL1	0.298	0.288	HL1	0.3093	0.2993	JL1	0.3231	0.312	KL1	0.3361	0.3245
	0.289	0.2905		0.3009	0.3042		0.3068	0.3113		0.3222	0.3243		0.3366	0.3369
	0.295	0.297		0.3068	0.3113		0.3144	0.3186		0.329	0.33		0.344	0.3428
	0.298	0.288		0.3037	0.2937		0.3161	0.3059		0.329	0.318		0.3429	0.3307
FL2	0.275	0.290	GL2	0.2695	0.3135	HL2	0.3020	0.3304	JL2	0.3207	0.3462	KL2	0.3376	0.3616
	0.2718	0.3036		0.2864	0.3221		0.3005	0.3415		0.3196	0.3602		0.3381	0.3762
	0.279	0.313		0.2937	0.3312		0.3099	0.3509		0.329	0.369		0.348	0.384
	0.28225	0.30575		0.2962	0.322		0.3115	0.3391		0.329	0.3538		0.3463	0.3687
FU1	0.275	0.290	GU1	0.2695	0.3135	HU1	0.3020	0.3304	JU1	0.3207	0.3462	KU1	0.3376	0.3616
	0.2718	0.3036		0.2864	0.3221		0.3005	0.3415		0.3196	0.3602		0.3381	0.3762
	0.279	0.313		0.2937	0.3312		0.3099	0.3509		0.329	0.369		0.348	0.384
	0.28225	0.30575		0.2962	0.322		0.3115	0.3391		0.329	0.3538		0.3463	0.3687
FU2	0.2064	0.3221	GU2	0.3005	0.3415	HU2	0.3196	0.3602	JU2	0.3301	0.3762	KU2	0.3371	0.3907
	0.2895	0.3135		0.3028	0.3304		0.3205	0.3481		0.3376	0.3616		0.3551	0.376
	0.292	0.306		0.3048	0.3207		0.3213	0.3373		0.3371	0.349		0.3533	0.362
	0.2855	0.2985		0.2984	0.3133		0.313	0.329		0.329	0.3417		0.3451	0.3554

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Color Temperature Coordinates



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Product Characteristics

Absolute Maximum Ratings

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	T _J (°C)	T _{OP} (°C)	T _{ST} (°C)
HT-T3212DND	White	1000	150	200	110	-35°C~+80°C	-40°C~+85°C

* Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

**Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

Electro-Optical Characteristics

(T_a 25 °C)

Product	Emission Color	I _F (mA)	V _F (V)		Color	Flux (lm)
			typ	max	C.I.E.	typ
HT-T3212DND	White	150	6.0	7.0	X=0.33 Y=0.33	100

* Per NIST standards

Package Outline Dimension

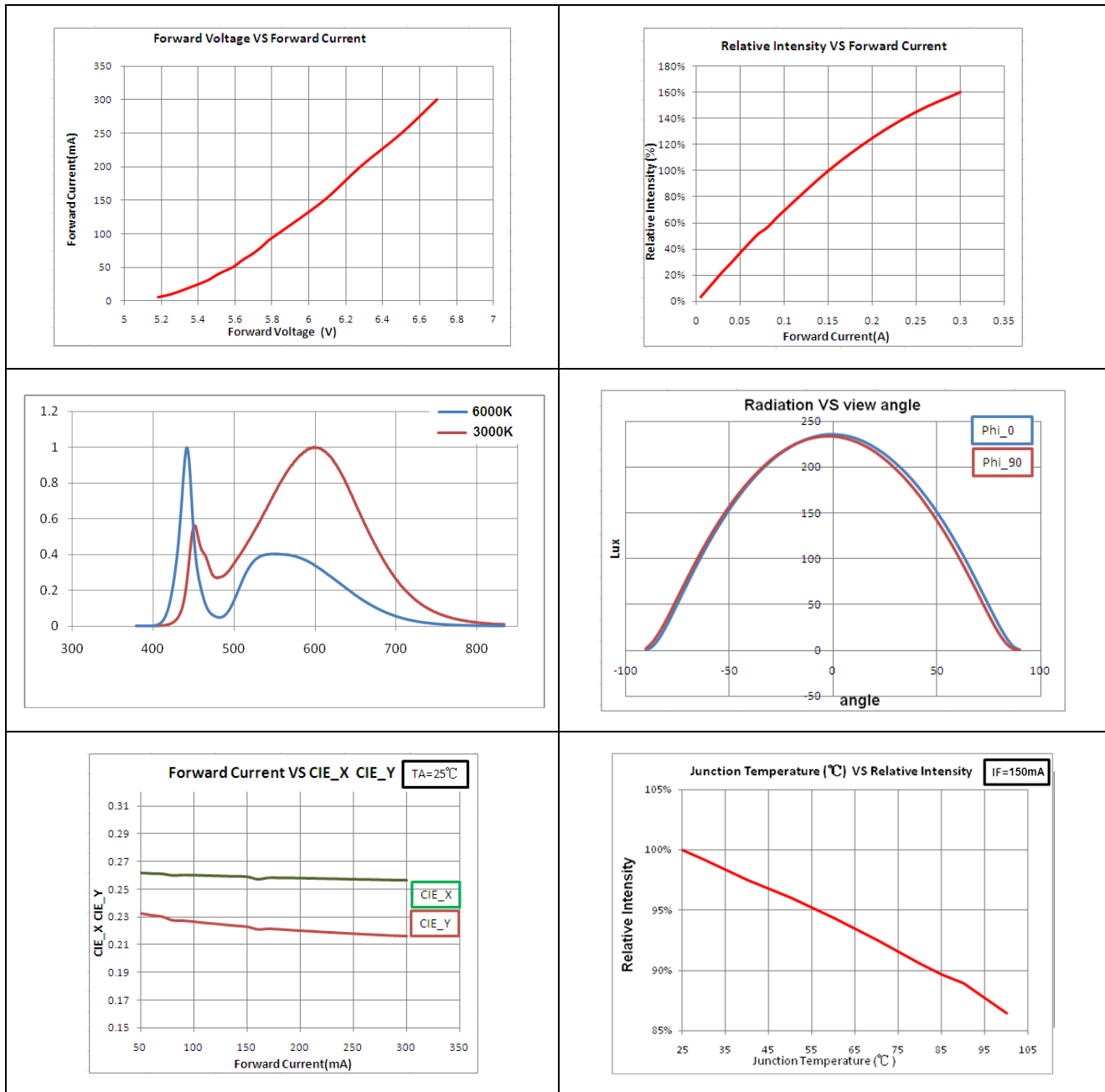
Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1

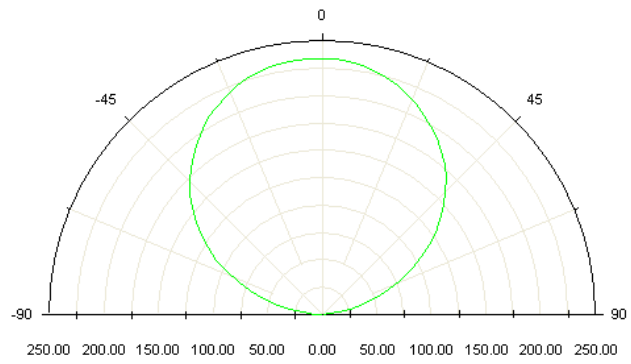
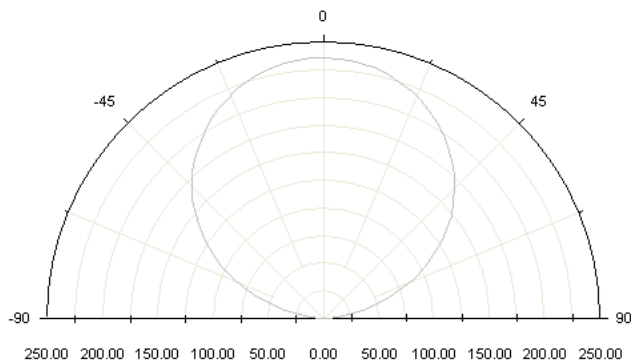
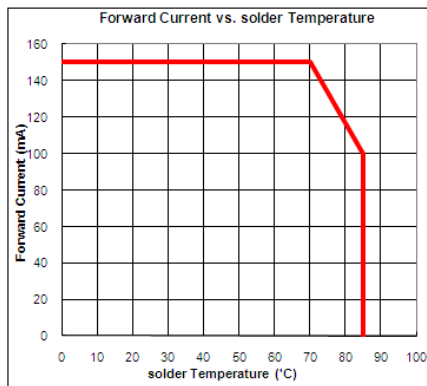
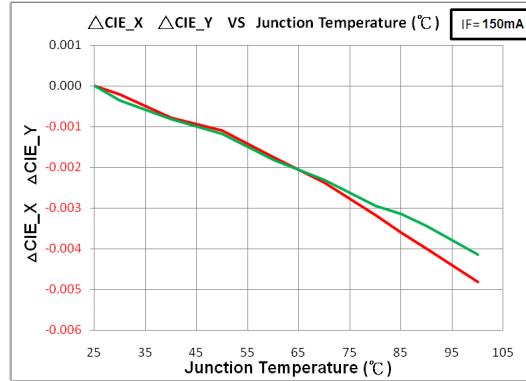
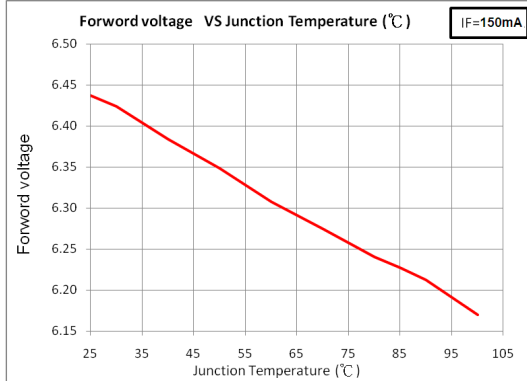
Outline Dimension	Solder Pattern
Soldering terminals may shift in the x, y direction.	Unit: mm

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Characteristic Curves for TW



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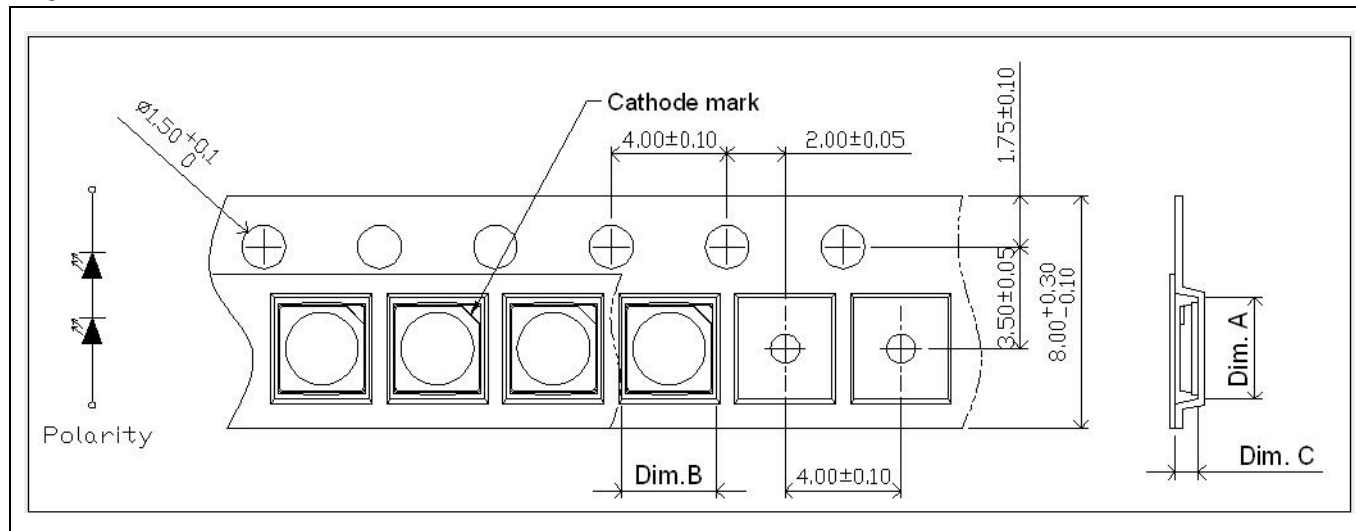
Reliability Test

RA Test (Preconditioning acc.to.Jedec Level 1)			
Test items	Test condition	Duration	Sample Size
Resistance to Soldering Heat(RTSH)	IR-Reflow,260 ° C	1x/2x/3x	36
Temp. Cycle Test (TCT)	-40/100 ° C	0/100/300 Cycles	36
High Temp. with Bias(HTB)	85 ° C,If= 150mA	0/100/300/500/1000hrs	36
Temp. & Humidity with Bias (THB)	60 ° C/90%,If= 150mA	0/100/300/500/1000hrs	36
Temp. & Humidity with Bias (THB)	85 ° C/85%,If= 150mA	0/100/300/500/1000hrs	36
High Temp. Storage (HTS)	100 ° C	0/100/300/500/1000hrs	36
Low Temp. Storage (LTS)	-40 ° C	0/100/300/500/1000hrs	36
Pulse Life Test(PLT)	TA=25°C , tp=10ms DC=0.1 D=tp/T IF=500mA	0/100/300/500/1000hrs	36
Thermal Shock Test (TST)	-40/85 ° C	0/100/500 Cycles	36
Operating Life Test (OLT)	25 ° C,If= 150mA	0/100/300/500/1000hrs	36
ESD(HBM)	(Human Body Model)	0/1KV/2KV/5KV	36
Sulphur Test(硫化測試)	30 ° C/70% Mixed gas with H2S0.75PPM NO2,1.5PPM	0/168HRS	36
Ag Migration	85 ° C/85% Vr=50	0/100/300/500/1000hrs	36

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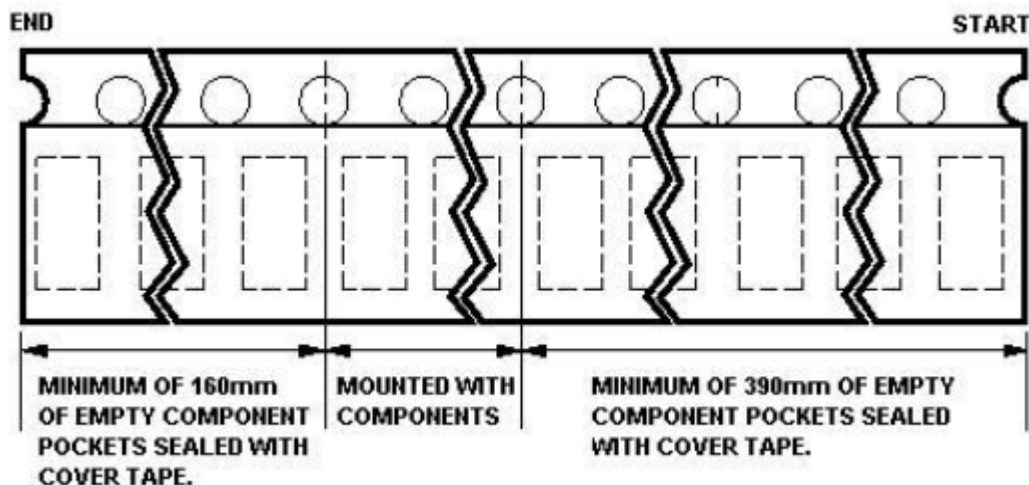
Packaging

Tape Dimension



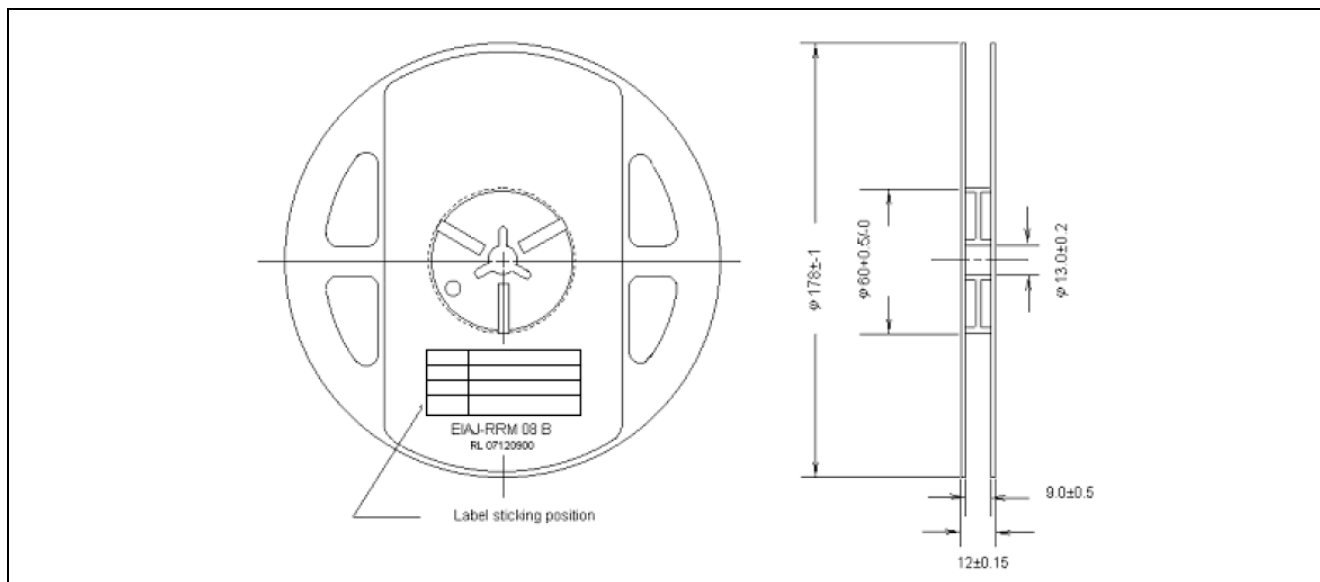
Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-T3212	3.49±0.1	3.26±0.1	0.78±0.1	2K

Unit: mm

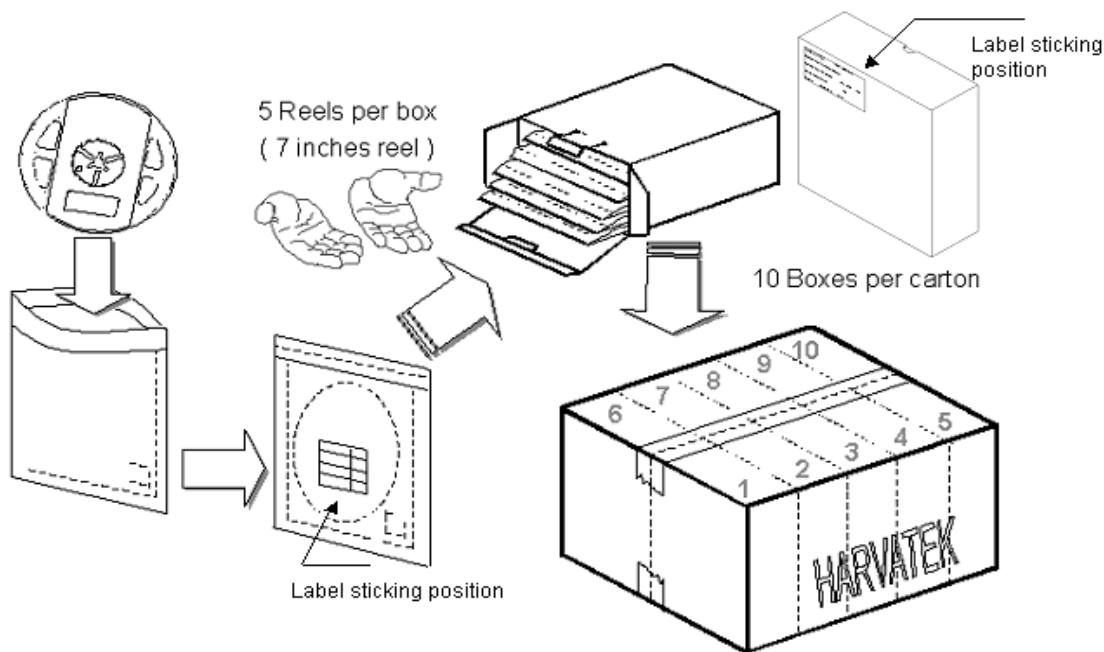


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Reel Dimension



Packing



5 boxes per carton is available depending on shipment quantity.

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Precaution of Application

Designing 1: Soldering pattern

The dimensions of the recommended soldering pattern may not meet every user. Please confirm and study first before designing the soldering pattern in order to obtain the best performance of soldering.

Designing 2: Circuit layout

Due to the circuit design is not available, assuming the circuit is in parallel and a resistor that is put in series in the circuit, it cannot provide an effective current-limiting function to the LEDs due to each LED had a different inherent resistance.

In general, the LEDs usually have a different inherent resistance. Different inherent resistance will cause different current, the LED on the different path would be driven at different power, and the result was the LED with a higher resistance would be dimmer than the other.

To solve this situation, a suitable resistor is put in series with each LED to limit the current disparity through the LED will be very useful.

Designing 3: Max Rating

Any application should refer to the specifications of absolute maximum ratings.

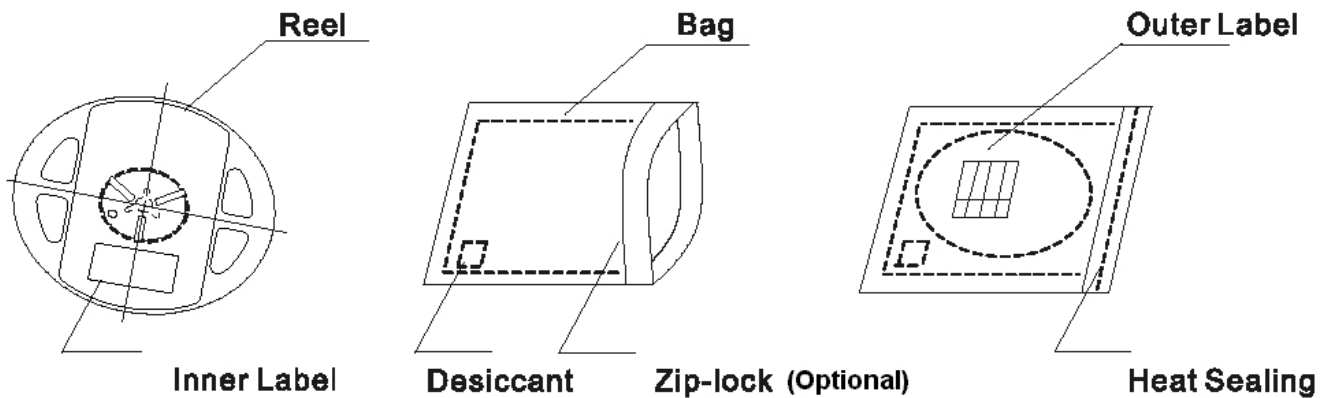
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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



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Storage

It's recommended to store the products in the following conditions:

Humidity: 60 %RH Max.

Temperature: 5°C ~30°C (41°F~86°F)

1. Shelf life in sealed bag: 12 month at<40 OC and <90%RH. (Base on aluminum laminated moisture barrier bag.)
2. After the bag is opened, devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing must be:
 - 2.1 Mounted within 72 hours at factory conditions of 30 OC /60% RH, or
 - 2.2 Stored at 20% RH with zip-lock sealed.

Baking

It's recommended to bake before soldering once the pack is unsealed open & re-sealed after 72 hours. The conditions are as followings:

60±3°C (12~24hrs) and < 5% RH, taped reel type

100±3°C (45min~1hr), bulk type

130±3°C (15~30min), bulk type

Soldering

Manual soldering (We do not recommend this method strongly.)

Soldering wire: 63/37 Sn/Pb, flux contained.

To prevent cracking, please bake before manual soldering, if the device is subject to moisture.

Temperature at tip of soldering tool: 300°C±5°C Max.(25W)

It's banned to load any stress on the resin during soldering.

Soldering time: 3±1sec

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Handling of Silicone Resin LEDs

Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.



Figure 1

In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.

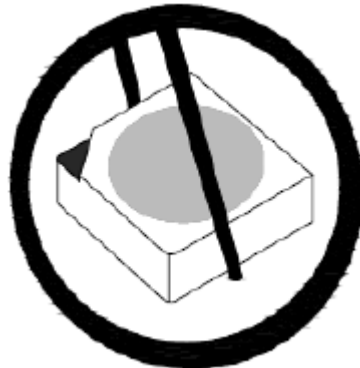


Figure 2

When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented.

This is assured by choosing a pick and place nozzle which is large than LEDs reflector area.

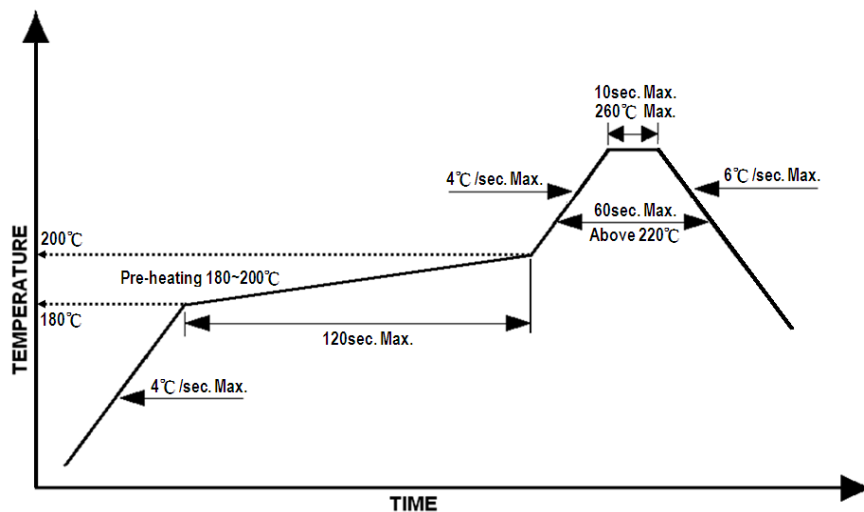
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Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 220°C, 60 sec.
2. Peak temp.:260°C Max., 10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never attempt next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

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Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial release		1.0	06-25-2013

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